

**Pb-free  
HEAT**



# AN1105W

Surface Mount IRED/Dome Lens Type

## Features

Package	3216 Dome lens type, Water clear epoxy
Product features	<ul style="list-style-type: none"> <li>• Outer Dimension 3.2 x 1.6 x 1.85mm ( L x W x H )</li> <li>• High Radiant Intensity : 1.4mW/sr TYP. (I<sub>F</sub>=20mA)</li> <li>• Total Output Power : 2mW TYP. (I<sub>F</sub>=20mA)</li> <li>• Surface Mount Type and Reverse Mount Type are possible.</li> <li>• No lead package</li> <li>• Lead-free soldering compatible</li> </ul>
Peak Wavelength	950nm
Half Intensity Angle	30 deg.
Die materials	GaAs
Rank grouping parameter	Sorted by radiant intensity per rank taping
Assembly method	Auto pick & place machine (Auto Mounter)
Soldering methods	Reflow soldering, TTW (Through The Wave) soldering and manual soldering ※Please refer to Soldering Conditions about soldering.
Taping and reel	2,000pcs per reel in a 8mm width tape. (Standard) Reel diameter: $\phi$ 180mm
ESD	2kV (HBM)

## Recommended Applications

Car Audio, Electric Household Appliances, OA/FA, PC/Peripheral Equipment, Other General Applications

## Absolute Maximum Ratings

(Ta=25°C)

Item	Symbol	Absolute Maximum Ratings	Unit
Power Dissipation	Pd	75	mW
Forward Current	I <sub>F</sub>	50	mA
Pulse Forward Current <sup>1</sup>	I <sub>FRM</sub>	300	mA
Derating (Ta=25 or higher)	I <sub>F</sub>	0.67	mA/
	I <sub>FRM</sub>	4	mA/
Reverse Voltage	V <sub>R</sub>	5	V
Operating Temperature	T <sub>opr</sub>	-30 ~ +85	
Storage Temperature	T <sub>stg</sub>	-40 ~ +100	

1 IFRM Measurement condition : Pulse Width 100 μ s, Duty 1/100

## Electro-Optical Characteristics

(Ta=25°C)

Item	Conditions	Symbol	Characteristics		Unit
			TYP.	MAX.	
Forward Voltage	I <sub>F</sub> =20mA	V <sub>F</sub>	TYP.	1.22	V
			MAX.	1.4	
Reverse Current	V <sub>R</sub> =5V	I <sub>R</sub>	MAX.	10	μ A
Radiant Intensity	I <sub>F</sub> =20mA	I <sub>E</sub>	MIN.	1	mW/sr
			TYP.	1.4	
Total Output Power	I <sub>F</sub> =20mA	P <sub>o</sub>	TYP.	2	mW
Peak Wavelength	I <sub>F</sub> =20mA	λ <sub>p</sub>	TYP.	950	nm
Spectral Half-width	I <sub>F</sub> =20mA		TYP.	45	nm
Half Intensity Angle	I <sub>F</sub> =20mA	2 1/2	TYP.	30	deg.
Cut-off Frequency	I <sub>F</sub> =20mA <sub>DC</sub> ± 5mA, -3db from 0.1MHz	fc	MIN.	-	MHz
			TYP.	0.5	
Response Time	I <sub>F</sub> =20mA	tr/tf	TYP.	700	ns

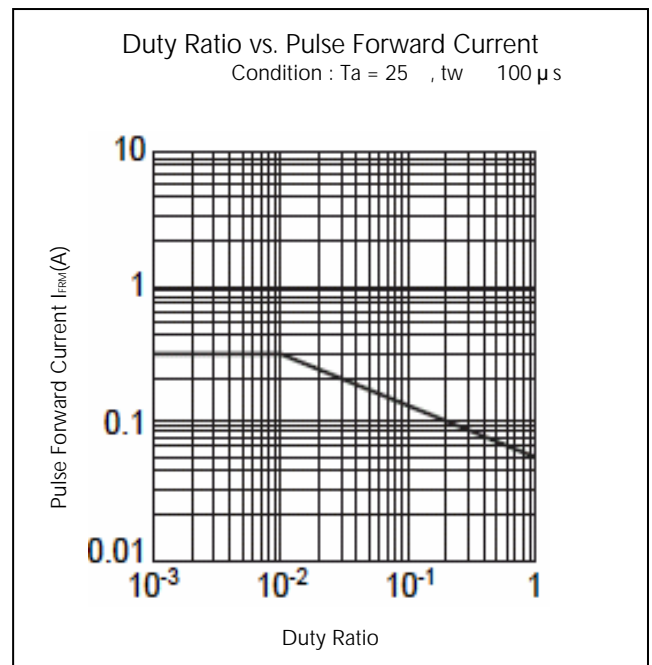
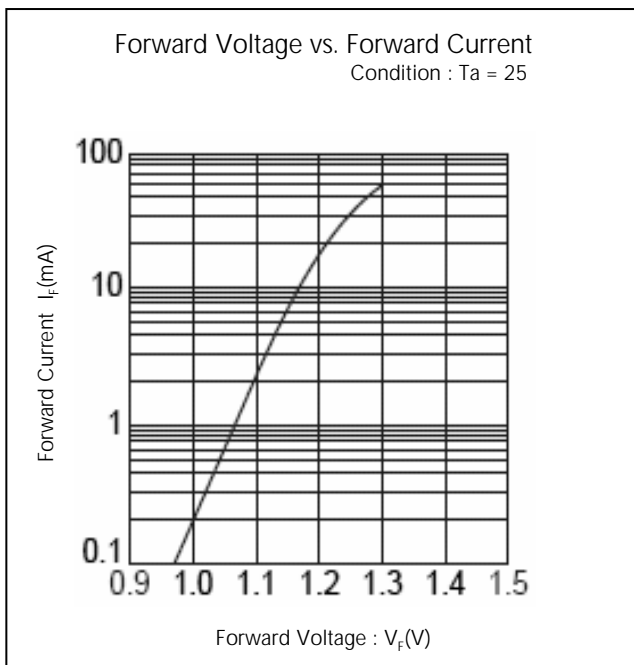
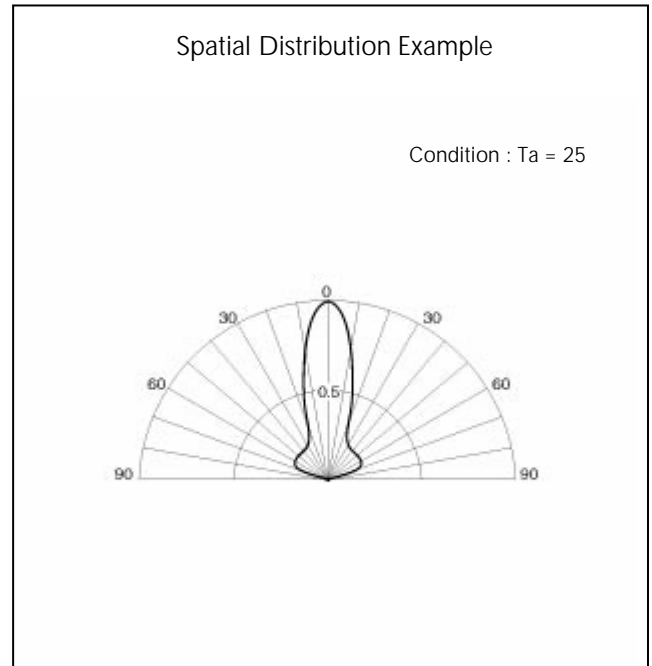
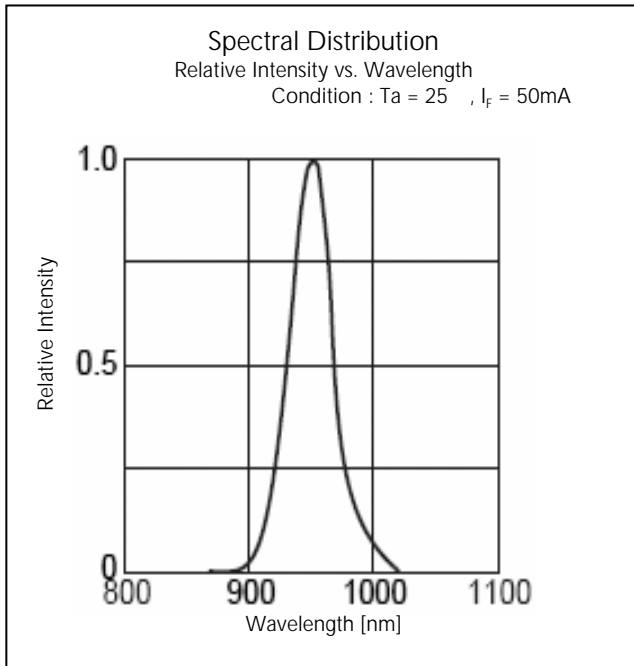
## Radiant Intensity Rank

(Ta=25°C)

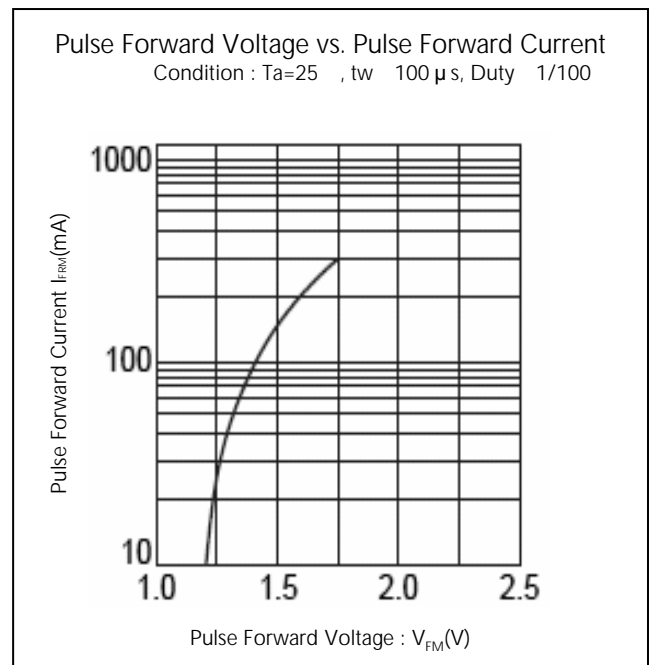
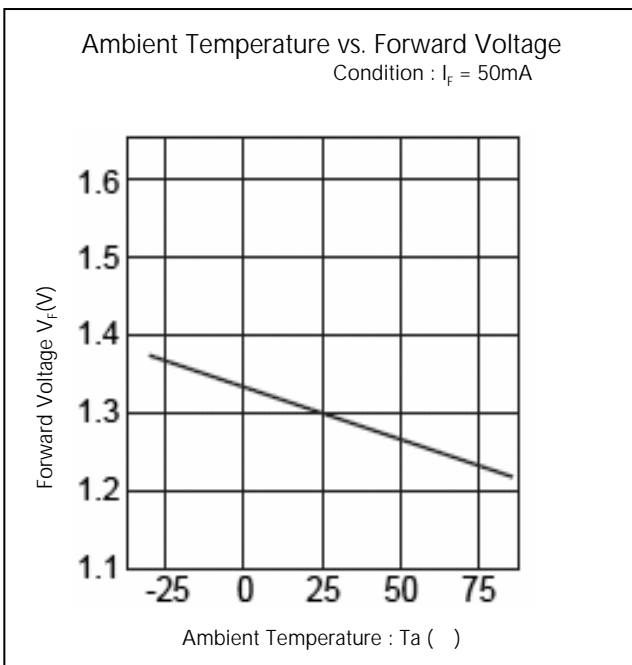
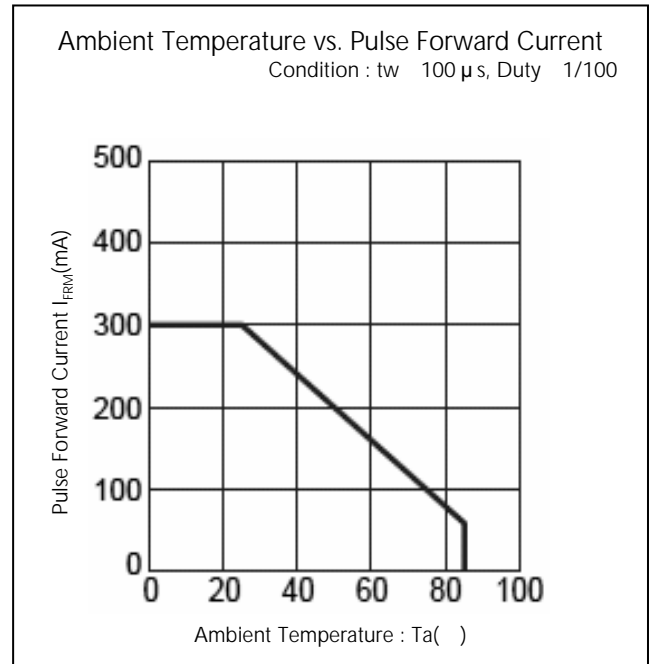
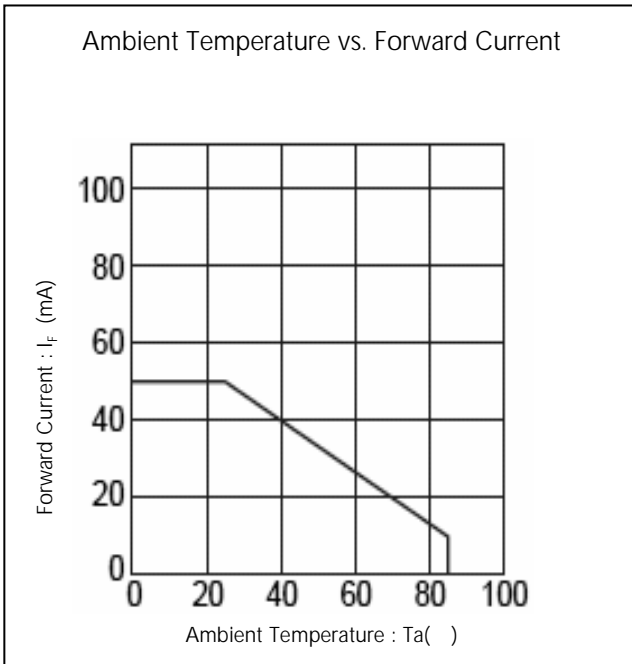
Rank	I <sub>E</sub> (mW/sr)		Condition
	MIN.	MAX.	
A	1.0	2.0	I <sub>F</sub> = 20mA
B	1.4	2.8	
C	2.0	4.0	

Please contact our sales staff concerning rank designation.

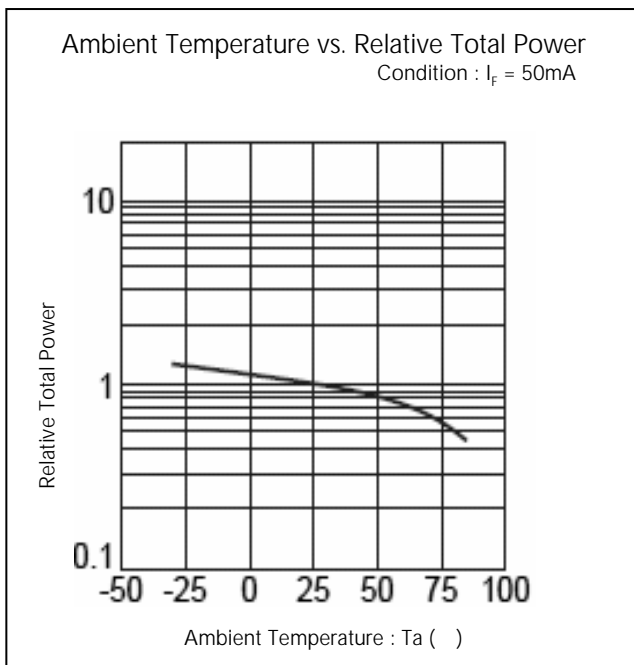
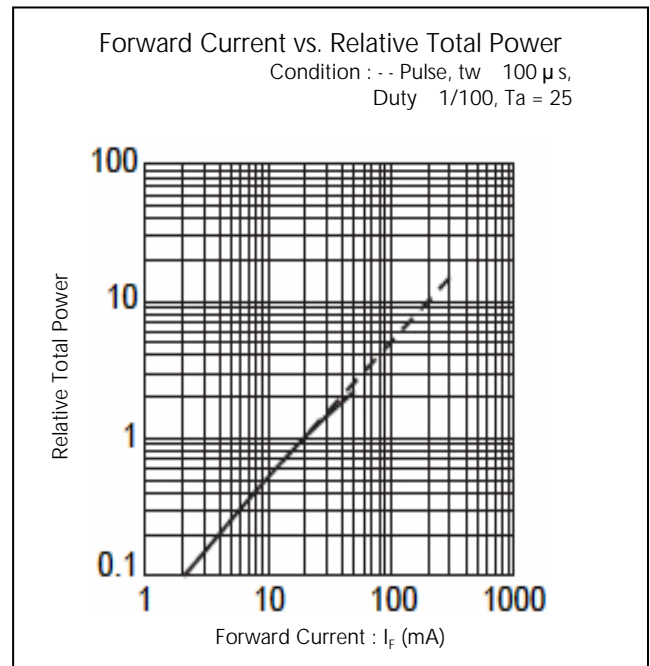
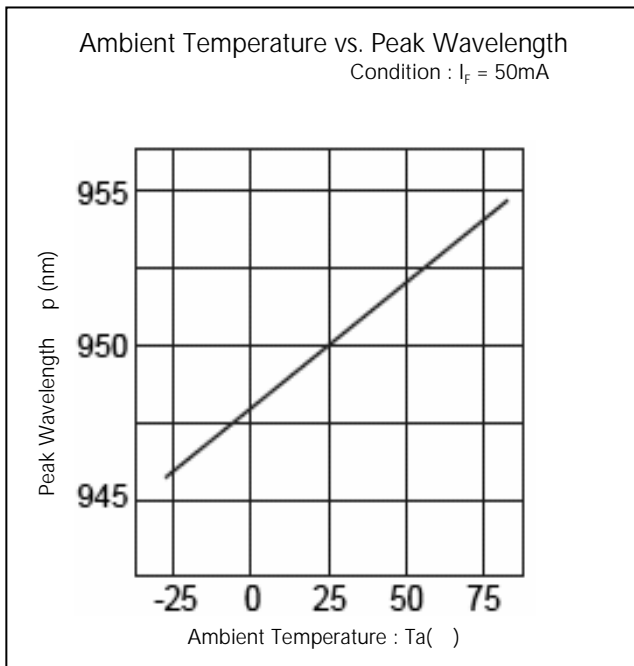
## Technical Data



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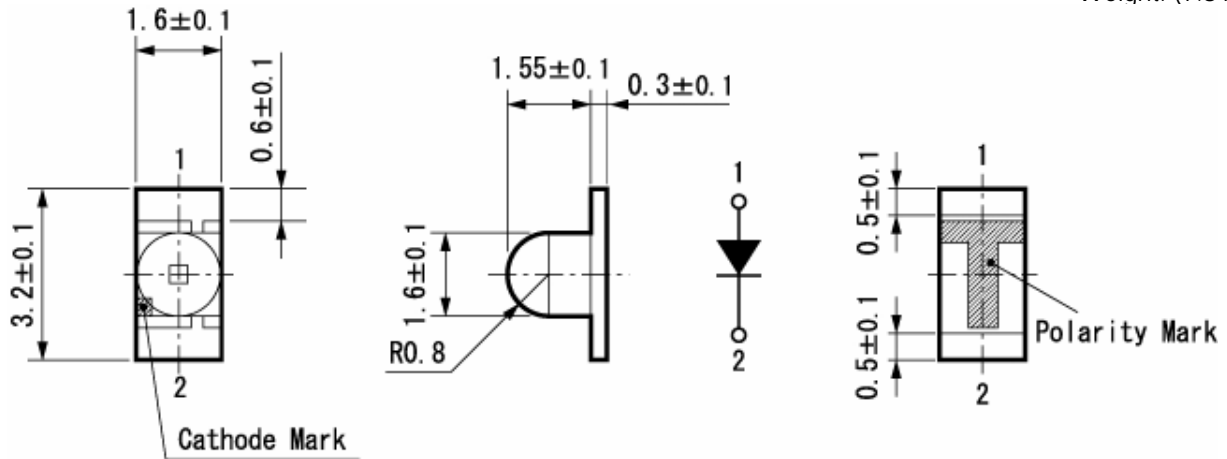
## Technical Data



## Package Dimensions

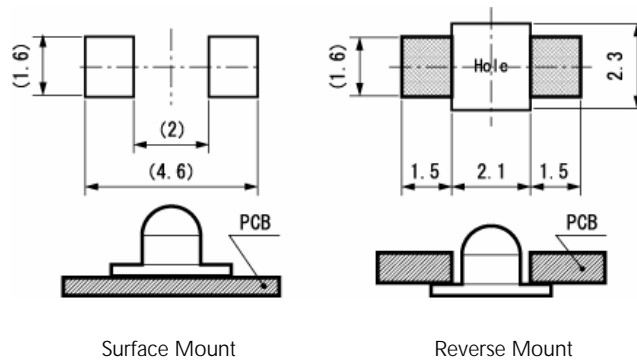
(Unit: mm)

Weight: (7.81)mg



## Recommended Soldering Pattern

(Unit: mm)



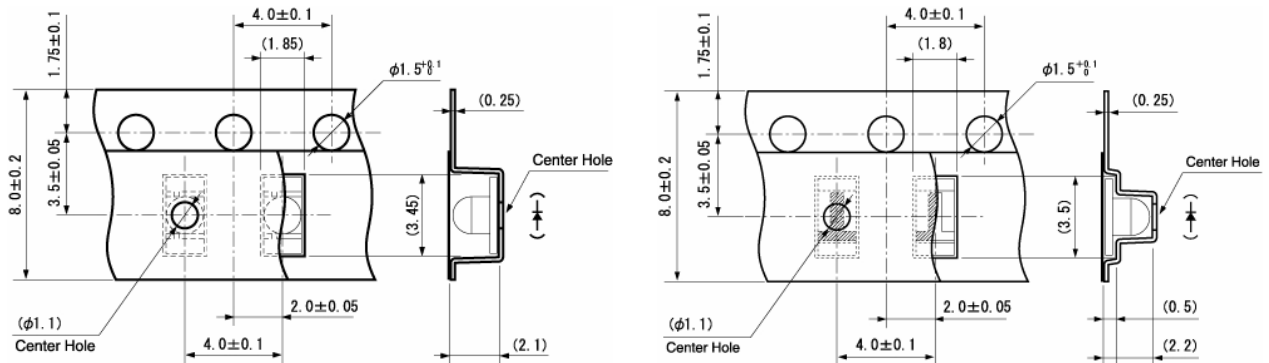
## Taping Specification

(Unit: mm)

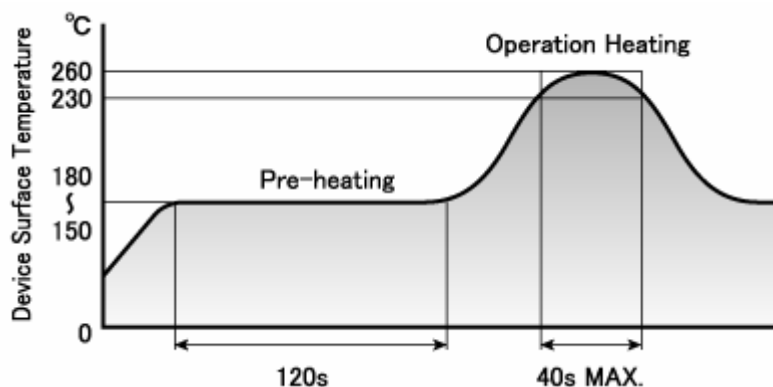
Quantity: 2,000pcs/ reel (standard)

1105W-TR (Surface Mount)

1105W-RR (Reverse Mount)



## Reflow Soldering Conditions



- 1) The above profile temperature gives the maximum temperature of the LED resin surface. Please set the temperature so as to avoid exceeding this range.
- 2) Total times of reflow soldering process shall be no more than 2 times. When the second reflow soldering process is performed, intervals between the first and second reflow should be short as possible (while allowing some time for the component to return to normal temperature after the first reflow) in order to prevent the LED from absorbing moisture.
- 3) Temperature fluctuation to the LED during the pre-heating process shall be minimized.

## TTW (Through The Wave) soldering Conditions

Pre-heating	120 ~ 150 (MAX.)	
	60 s ~ 120 s (MAX.)	
Solder Bath Temp.	265	(MAX.)
Dipping Time	5 s	(MAX.)

- 1) The dip soldering process shall be 2 times maximum.
- 2) The product shall be cooled to normal temperature before the second dipping process.

## Manual Soldering Conditions

Iron tip temp.	350	(MAX.) (30 W Max.)
Soldering time and frequency	3 s	(MAX.)
	1 time	(MAX.)



## Reliability Testing Result

Reliability Testing Result	Applicable Standard	Testing Conditions	Duration	Failure
Room Temp. Operating Life	EIAJ ED-4701/100(101)	Ta = 25°C, If = Maximum Rated Current	1,000 h	0/25
Resistance to Soldering Heat	EIAJ ED-4701/300(301)	(Pretreatment) Individual standard (Reflow Soldering) Pre-heating 150°C 120s →Operating Heating 240°C 5s	-	0/25
		(Pretreatment) Individual standard (Reflow Soldering) Pre-heating 180°C 120s →Operating Heating 260°C 5s	-	0/25
Temperature Cycling	EIAJ ED-4701/100(105)	Minimum Rated Storage Temperature(30min) ~Normal Temperature(15min) ~Maximum Rated Storage Temperature(30min) ~Normal Temperature(15min)	5 cycles	0/25
Wet High Temp. Storage Life	EIAJ ED-4701/100(103)	Ta = 60±2°C, RH = 90±5%	1,000 h	0/25
High Temp. Storage Life	EIAJ ED-4701/200(201)	Ta = Maximum Rated Storage Temperature	1,000 h	0/25
Low Temp. Storage Life	EIAJ ED-4701/200(202)	Ta = Minimum Rated Storage Temperature	1,000 h	0/25
Vibration, Variable Frequency	EIAJ ED-4701/400(403)	98.1m/s <sup>2</sup> (10G), 100 ~ 2KHz sweep for 20min., XYZ each direction	2 h	0/10

## Failure Criteria

Items	Symbols	Conditions	Failure criteria
Radiant Intensity	I <sub>E</sub>	If Value of each product Radiant Intensity	Testing Min. Value < Initial Value x 0.5
Forward Voltage	V <sub>F</sub>	If Value of each product Forward Voltage	Testing Max. Value > Spec. Max. Value x 1.2
Reverse Current	I <sub>R</sub>	V <sub>R</sub> = Maximum Rated Reverse Voltage V	Testing Max. Value ≥ Spec. Max. Value x 2.5
Cosmetic Appearance	-	-	No notable, decoloration, deformation and cracking

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